SiHF23N60E

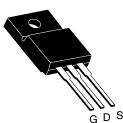
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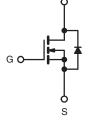


E Series Power MOSFET

PRODUCT SUMMARY					
V_{DS} (V) at T _J max.	650				
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.158			
Q _g max. (nC)	95				
Q _{gs} (nC)	16				
Q _{gd} (nC)	25				
Configuration	Single				

TO-220 FULLPAK





N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free and Halogen-free	SiHF23N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	600	v	
Gate-Source Voltage			V _{GS}	± 30	V	
Continuous Drain Current (T _J = 150 °C) $^{\circ}$	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		23		
	V _{GS} at 10 V	T _C = 100 °C	I _D	15	А	
Pulsed Drain Current ^a			I _{DM}	63		
Linear Derating Factor				0.28	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	353	mJ	
Maximum Power Dissipation			PD	35	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 125 °C		-1) / /-14	37		
Reverse Diode dV/dt ^d			dV/dt	34	V/ns	
Soldering Recommendations (Peak Temperature) ^c	for 10 s			300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D, \, dI/dt$ = 100 A/µs, starting T_J = 25 °C.

e. Limited by maximum junction temperature.

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1 For technical questions, contact: <u>hvm@vishay.com</u>



RoHS COMPLIANT

FREE



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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
		11F.		65 3.6		- °C/W		
Maximum Junction-to-Ambient	R _{thJA}	-						
Maximum Junction-to-Case (Drain)	R _{thJC}	-						
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static	•							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$		600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.72	-	V/°(
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		2	-	4	V
		$V_{GS} = \pm 20 V$		-	-	± 100	nA	
Gate-Source Leakage	$V_{GSS} = \pm 30 V$		V	-	-	± 1	μA	
Zaro Gata Valtago Drain Current	1-	V _{DS} =	= 600 V, V _G	_S = 0 V	-	-	1	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	-	10	μA	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 12 A		-	0.132	0.158	Ω	
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 12 A		-	6.4	-	S	
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	2418	-	pF	
Output Capacitance	C _{oss}			-	119	-		
Reverse Transfer Capacitance	C _{rss}			-	4	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	107	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	320	-		
Total Gate Charge	Qg	V _{GS} = 10 V I _D = 12 A, V _{DS} = 480 V			-	63	95	1
Gate-Source Charge	Q _{gs}			-	16	-	nC	
Gate-Drain Charge	Q _{gd}				-	25	-	1
Turn-On Delay Time	t _{d(on)}	V _{DD} = 480 V, I _D = 12 A,		-	22	44		
Rise Time	t _r			-	38	76	1	
Turn-Off Delay Time	t _{d(off)}		= 10 V, R _g =		-	66	99	ns
Fall Time	t _f	1		-	34	68	1	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.73	-	Ω	
Drain-Source Body Diode Characterist	cs							
Continuous Source-Drain Diode Current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	23	A	
Pulsed Diode Forward Current	I _{SM}			-	-	63		
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 12 A, V _{GS} = 0 V		-	0.9	1.2	V	
Reverse Recovery Time	t _{rr}				-	384	768	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 12 \text{ A},$ dl/dt = 100 A/µs, V _R = 25 V		-	6.4	12.8	μ	
Reverse Recovery Current	I _{RRM}			-	30	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

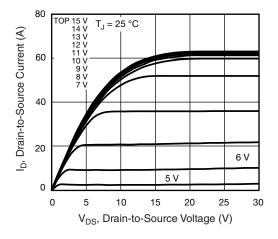


Fig. 1 - Typical Output Characteristics

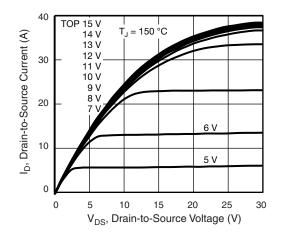
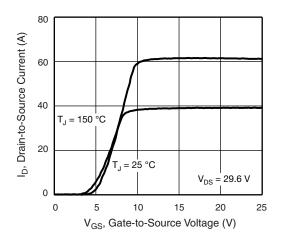


Fig. 2 - Typical Output Characteristics





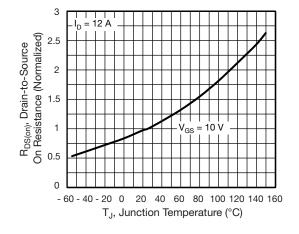


Fig. 4 - Normalized On-Resistance vs. Temperature

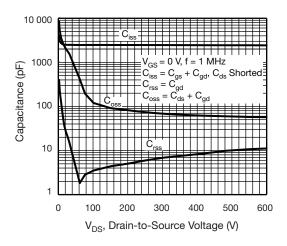


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

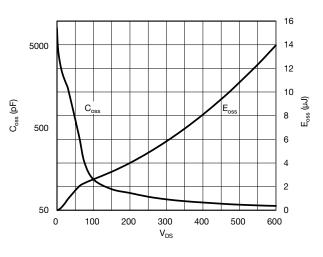


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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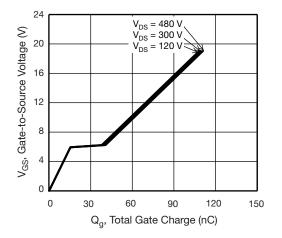


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

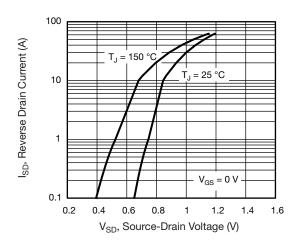


Fig. 8 - Typical Source-Drain Diode Forward Voltage

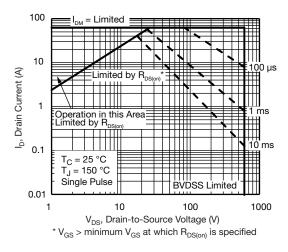


Fig. 9 - Maximum Safe Operating Area

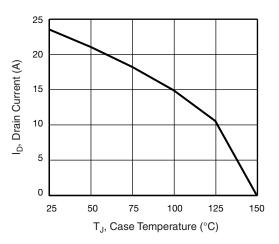


Fig. 10 - Maximum Drain Current vs. Case Temperature

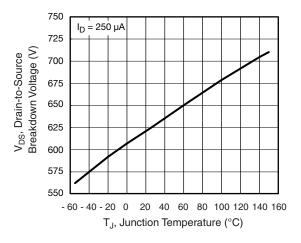


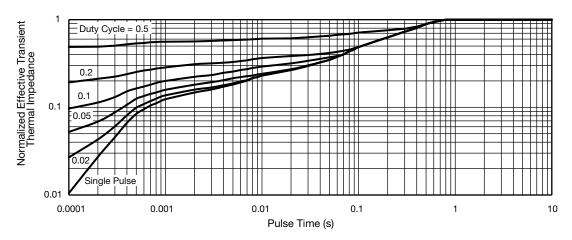
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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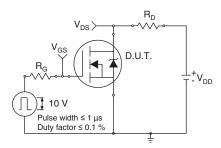


Fig. 13 - Switching Time Test Circuit

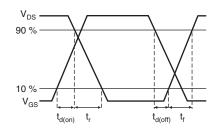


Fig. 14 - Switching Time Waveforms

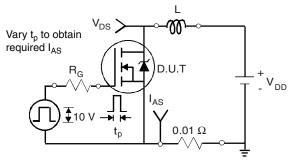


Fig. 15 - Unclamped Inductive Test Circuit

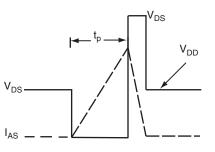


Fig. 16 - Unclamped Inductive Waveforms

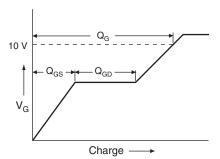


Fig. 17 - Basic Gate Charge Waveform

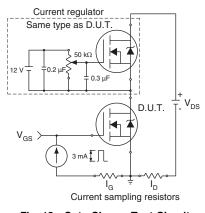


Fig. 18 - Gate Charge Test Circuit

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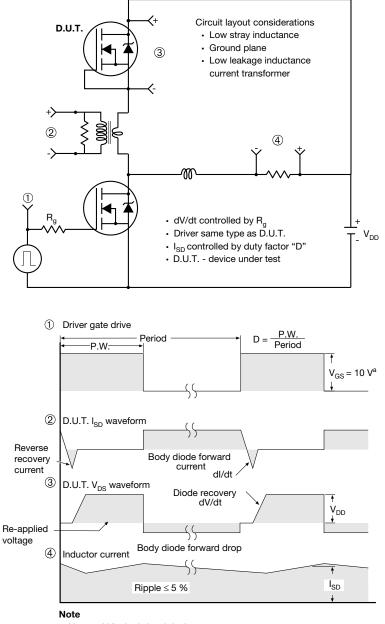
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 19 - For N-Channel

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